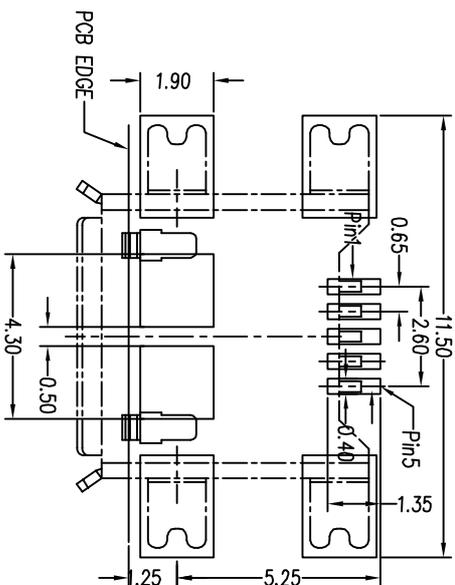
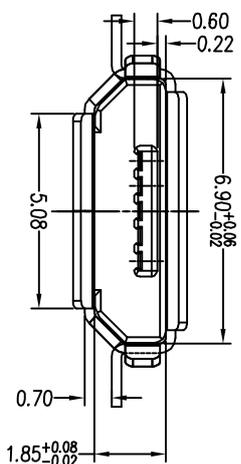
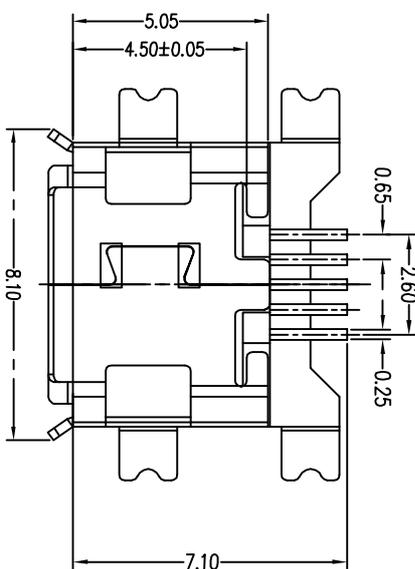
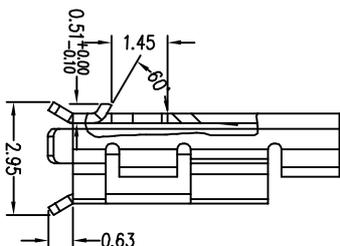
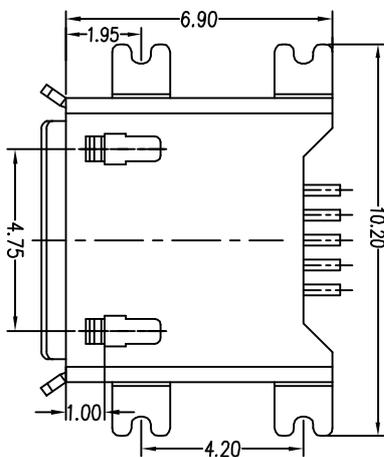
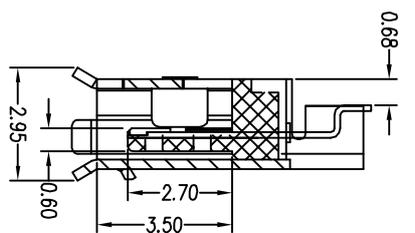
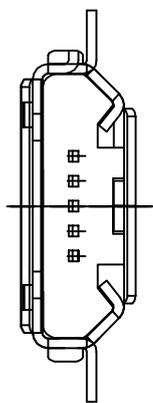


REV.	EQN NO	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD



RECOMMENDED PCB LAYOUT

- Note:
- Material:
 - Housing: High temperature thermoplastic with g.f.i.UL94V-0
 - Contact: copper alloy,t=0.20mm
 - Shell: copper alloy,t=0.25mm
 - Specification:
 - Current rating: 1 A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 50 mΩ Max.
 - Insulation resistance: 100 MΩ Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.after 10000 insertion/extraction cycles
 - Temperature range: -30C~80C

PART NO: 1-MD05SMXXX-01	MATERIAL: SEE NOTE	深圳市精拓金电子有限公司	
MODEL NO:	FINSH: SEE NOTE	TITLE: Micro usb 5s B Type (微插0.7)	
UNIT: mm	COLOR: SEE NOTE	CUSTOMER DRAWING	
SIZE: A4	DR: ???	DWG NO: A055	REV: A
TOLERANCE UNSPECIFIED	CHK: APP: 1:1	SCALE: 1:1	SHEET: 1/1
.x ±0.38			
.xx ±0.25			
.xxx ±0.13			
ANG. ±2°			

No.	Nome	Q'ty	Finish
3	Shell	1	N/A
2	Contact	5	N/A
1	Housing	1	N/A